Product Lineup 2024



Leading Manufacturer of Clean Robot

SCR3160CSN-300-CM

3-Axis Cylindrical Coordinate Type Single-Arm Clean Robot

Clean Robot SCR3000CSN Series

Featuring a step-out-less closed-loop control system, built-in batteryless absolute encoders and stepping motors, this series ensures high convenience, safety and stability as well as various ways of transferring. Suitable for various types of wafers up to 300 mm.



Characteristics

- ◆ Step-out-less closed-loop control system under rapid load change or acceleration
- Equipped with batteryless multi-rotation absolute sensors.
- ◆ Path planning handling suitable for parallel layout is optional.
- ◆ Payload capacity: 3 kg or less (calculated on the arm 3rd joint)
- Compatible with the former SHR model and current SCR3000CS series, this SCR3000CSN series ensures easier replacement.

Specifications

Carrying object	Wafers up to 300 mm			
	Arm	Rotation angle	Vertical stroke	
Operating range* (3rd joint center)	340 mm	340 degrees	300 mm	
Speed (Avg)*	610 mm/sec	340 degree/sec	250 mm/sec	
Speed (Max)*	1220 mm/sec	500 degree/sec	320 mm/sec	
Resolution*	10,0 μm or less	0.0015 degrees	2,00 μm	
Handling level*	536 mm (Base mounting level to the end-effector level)			
Repeatability	Within +/- 0.1 mm			
Cleanliness	ISO Class 2 (when exhausted from the driving area)			
Utility*	Power: 24 V DC +/-	- 10%, 10 A; Vacuum	n: -53 kPa or more	

- *Specifications of SCR3160CSN-300-CM with a JEL standard vacuum type end-effector.

 Provide positive pressure depending on the wafer holding method such as edge grip or Bernoulli.
- Robot's main body weight: Approximately 22 kg
- Dimensions of C4000B controller: 297 (W) x 180 (D) x 120 (H), Weight: Approximately 5 kg Note: A CE/KCs compliant controller has different dimensions and weight.

SCR3000 series

◆ A wide range of variations to meet system layouts



 Check our website for our product drawings and videos.

https://www.jel-robot.com

jel Search



STCR4160SN-300-CM

4-Axis Cylindrical Coordinate Type Twin-Arm Clean Robot

Clean Robot STCR4000SN Series

Featuring a step-out-less closed-loop control system, built-in batteryless absolute encoders and stepping motors, this series ensures high convenience, safety and stability as well as various ways of transferring. Suitable for various types of wafers up to 300 mm.













Option







● Transfer method







Controller: C4000B

Control method: RS232C and parallel photo I/O



Teaching box: JCT3B

Characteristics

- Twin-arm reduces tact time to replace wafers.
- ◆ Step-out-less closed-loop control system under rapid load change or acceleration
- Equipped with batteryless multi-rotation absolute sensors.
- ◆ Path planning handling suitable for parallel layout is optional.
- Payload capacity: 3 kg or less (calculated on the arm 3rd joint)
- Compatible with the former STHR model and current STCR4000S series, this STCR4000SN series ensures easier replacement.

Specifications

Carrying object	Wafers up to 300 mm			
	Arm	Rotation angle	Vertical stroke	
Operating range* (3rd joint center)	315 mm	340 degrees	300 mm	
Speed (Avg)*	570 mm/sec	220 degree/sec	200 mm/sec	
Speed (Max)*	1140 mm/sec	270 degree/sec	250 mm/sec	
Resolution*	12.6 μm or less	0.0045 degrees	6.25 μm	
Handling level*	620 mm (Base mo	unting level to the en	d-effector level)	
Repeatability	Within +/- 0.1 mm			
Cleanliness	ISO Class 2 (when exhausted from the driving area)			
Utility*	Power: 24 V DC +/-	- 10%, 10 A; Vacuum	: -53 kPa or more	

*Specifications of STCR4160SN-300-CM with JEL standard vacuum type twin end-effectors.

Provide positive pressure depending on the wafer holding method such as edge grip or Bernoulli.

- Robot's main body weight: Approximately 30 kg
- Dimensions of C4000B controller: 297 (W) x 180 (D) x 120 (H), Weight: Approximately 5 kg
 Note: A CE/KCs compliant controller has different dimensions and weight.

STCR4000 series

♦ A wide range of variations to meet system layouts

S T C R 4 1 6 0 S N - 3 0 0 - C M

Arm length			
1	0	0	
1	3	0	
2	0	0	

Z-ax			
2	0	0	
4	0	0	*
5	0	0	*
6	0	0	*

*Optional variation

 Check our website for our product drawings and videos.

https://www.jel-robot.com







SCR3160CS-300-PM

3-Axis Cylindrical Coordinate Type Single-Arm Clean Robot

Clean Robot SCR3000CS Series

Featuring an open-loop control system and stepping motors, this series ensures high safety and stability. This JEL's long-term standard robot allows users to customize easily. Suitable for various types of wafers up to 300 mm.



Characteristics

- ◆ Base or flange mounting type is selectable according to system layouts.
- ◆ Optimal end-effector is selectable according to the carrying object and line layout.
- Payload capacity: 3 kg or less (calculated on the arm 3rd joint)
- Compatible with the former SHR model and current SCR3000CSN series, this SCR3000CS series ensures easier replacement.

Specifications

Carrying object	Wafers up to 300 mm			
	Arm	Rotation angle	Vertical stroke	
Operating range* (3rd joint center)	340 mm	340 degrees	300 mm	
Speed (Avg)*	610 mm/sec	340 degree/sec	250 mm/sec	
Speed (Max)*	1220 mm/sec	500 degree/sec	320 mm/sec	
Resolution*	12.6 μm or less	0.0045 degrees	6.25 μm	
Handling level*	536 mm (Base mo	536 mm (Base mounting level to the end-effector level)		
Repeatability	Within +/- 0.1 mm			
Cleanliness	ISO Class 2 (when exhausted from the driving area)			
Utility*	Power: 24 V DC +/	- 10%, 15 A; Vacuum	: -53 kPa or more	

- *Specifications of SCR3160CS-300-PM with a JEL standard vacuum type end-effector.

 Provide positive pressure depending on the wafer holding method such as edge grip or Bernoulli.
- Robot's main body weight: Approximately 20 kg
- Dimensions of C4000 controller: 300 (W) x 110 (D) x 120 (H), Weight: Approximately 2 kg Note: A CE/KCs compliant controller has different dimensions and weight.

SCR3000 series

♦ A wide range of variations to meet system layouts



Optional variation

 Check our website for our product drawings and videos.

https://www.jel-robot.com

jel

Search



STCR4160S-300-PM

4-Axis Cylindrical Coordinate Type Twin-Arm Clean Robot

Clean Robot STCR4000S series

Featuring an open-loop control system and stepping motors, this series ensures high safety and stability. This JEL's long-term standard robot allows users to customize easily. Suitable for various types of wafers up to 300 mm.



Characteristics

- ◆ Twin-arm reduces tact time to replace wafers.
- ◆ Base or flange mounting type is selectable according to system layouts.
- ◆ Optimal end-effector is selectable according to the carrying object and line layout.
- ◆ Payload capacity: 3 kg or less (calculated on the arm 3rd joint)
- ◆ Compatible with the former STHR model and current STCR4000SN series, this STCR4000S series ensures easier replacement.

Specifications

*CE marking is available upon request.

Carrying object	Wafers up to 300 mm			
	Arm	Rotation angle	Vertical stroke	
Operating range* (3rd joint center)	315 mm	340 degrees	300 mm	
Speed (Avg)*	570 mm/sec	220 degree/sec	200 mm/sec	
Speed (Max)*	1140 mm/sec	270 degree/sec	250 mm/sec	
Resolution*	12,6 μm or less	0.0045 degrees	6,25 μm	
Handling level*	620 mm (Base mo	620 mm (Base mounting level to the end-effector level)		
Repeatability	Within +/- 0,1 mm	Within +/- 0.1 mm		
Cleanliness	ISO Class 2 (when exhausted from the driving area)			
Utility*	Power: 24 V DC +/-	- 10%, 16 A; Vacuum	n: -53 kPa or more	

- *Specifications of STCR4160S-300-PM with JEL standard vacuum type twin end-effectors. Provide positive pressure depending on the wafer holding method such as edge grip or Bernoulli.
- Robot's main body weight: Approximately 30 kg
 Dimensions of C4000 controller: 300 (W) x 110 (D) x 120 (H), Weight: Approximately 2 kg Note: A CE/KCs compliant controller has different dimensions and weight.

STCR4000 series

◆ A wide range of variations to meet system layouts

STCR4160S-300-PM

Arm length				
1 0 0				
1	3	0		
2	0	0		

5	U	U	-
Z-ax	is st	roke	
2	0	0	
4	0	0	*
5	0	0	*
6	0	0	*

*Optional variation

 Check our website for our product drawings and videos.

https://www.jel-robot.com



Search



Controller: C4000

 Control method: RS232C and parallel photo I/O



GCR4210-300-PM

4-Axis Horizontal and Multi-Joint Type Single-Arm Clean Robot

Clean Robot GCR4000-PM Series

Featuring stepping motors with absolute encoders, this series ensures high safety and stability. This JEL's long-term standard robot allows users to customize easily. Suitable for various types of wafers up to 300 mm.



Characteristics

- ◆ 2 FOUP access without a track
- ♦ Base or flange mounting type is selectable according to system layouts.
- ◆ Payload capacity: 3 kg or less (calculated on the arm 3rd joint)

Specifications

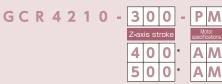
Carrying object	Wafers up to 300 mm			
	Arm	Rotation angle	Vertical stroke	
Operating range* (3rd joint center)	400 mm	335 degrees	300 mm	
Speed (Avg)*	730 mm/sec	280 degree/sec	200 mm/sec	
Speed (Max)*	1100 mm/sec	400 degree/sec	250 mm/sec	
Resolution*	0.0055 degrees	0,0025 degrees	6,25 μm	
Handling level*	620 mm (Base mou	unting level to the en	d-effector level)	
Repeatability	Within +/- 0.1 mm			
Cleanliness	ISO Class 2 (when exhausted from the driving area)			
Utility*	Power: 24 V DC +/-	- 10%, 15 A; Vacuum	n: -53 kPa or more	

- *Specifications of GCR4210-300-PM with a JEL standard vacuum type end-effector.

 Provide positive pressure depending on the wafer holding method such as edge grip or Bernoulli.
- This series comes in two types of motors: stepping motors or AC servo motors.
- Robot's main body weight: Approximately 28 kg
- Dimensions of C4451 controller: 300 (W) x 230 (D) x 142 (H), Weight: Approximately 2 kg Note: A CE/KCs compliant controller has different dimensions and weight.

GCR-PM series

◆ A wide range of variations to meet system layouts



*Optional variation

 Check our website for our product drawings and videos.

https://www.jel-robot.com



Search

Please contact our sales representatives for details of this product.



Controller: C4451

Control method: RS232C and

Teaching box: JCT5B

GTCR5280-300-AM

5-Axis Horizontal and Multi-Joint Type Single-Arm Twin End-Effector Clean Robot

Clean Robot GTCR5000 Series

Twin end-effectors mounted on its single-arm, this series has the same function as a twin-arm robot. AC servo motors capable of high-speed handling ensures high safety and stability. Suitable for various types of wafers or substrates as well as wafers up to 300 mm.



















Transfer method





Controller: C5000S Control method: RS232C and parallel photo I/O



Teaching box: JCT5B

Characteristics

- Capable of transferring large diameter wafers and small FPD glass substrates.
- ♦ High-speed 3 FOUP access without a track for 300 mm wafers.
- AC servo motors with absolute encoders are installed in all axes.
- ◆ High-speed and high-accuracy wafer handling by optimizing pass control.
- ◆ Payload capacity: 4 kg or less (calculated on the arm 3rd joint)

Specifications

Carrying object	Wafers up to 300 mm		
	Arm	Rotation angle	Vertical stroke
Operating range* (3rd joint center)	553 mm	335 degrees	300 mm
Speed (Avg)*	833 mm/sec	250 degree/sec	300 mm/sec
Speed (Max)*	1400 mm/sec	350 degree/sec	450 mm/sec
Resolution*	0.0011 degrees	0.0013 degrees	1.96 µm
Handling level*	698 mm (Base mo	unting level to the en	d-effector level)
Repeatability	Within +/- 0.1 mm		
Cleanliness	ISO Class 2 (when exhausted from the driving area)		
Utility*	Power: Single phase 20	00 V AC +/- 10%, 20 A; V	acuum: -53 kPa or more

- *Specifications of GTCR5280-300-AM with JEL standard vacuum type twin end-effectors. Provide positive pressure depending on the wafer or substrate holding method such as edge grip or Bernoulli.
- Robot's main body weight: Approximately 53 kg
- Dimensions of C5000S controller: 370 (W) x 330 (D) x 270 (H), Weight: Approximately 15 kg Note: A CE/KCs compliant controller has different dimensions and weight.

GTCR series

◆ A wide range of variations to meet system layouts



 Check our website for our product drawings and videos.

https://www.jel-robot.com







SVCR3260-020-PM

3-Axis Cylindrical Coordinate Type Single-Arm Clean Robot

Vacuum Clean Robot SVCR3000 Series

Suitable for various types of wafers up to 300 mm in a vacuum environment. Featuring an open-loop control system and stepping motors, this series ensures high safety and stability. This JEL's long-term standard robot allows users to customize easily.



Characteristics

- Suitable for vacuum environment
- ◆ Magnetic fluid sealing is used in each arm joint.
- ◆ Vacuum sealing: Magnetic fluid sealing and a bellows are used.
- ♦ Cleanliness: A mesh filter is installed for the internal exhaust of the arm.
- ◆ Payload capacity: 2 kg or less (calculated on the arm 3rd joint)
- ◆ Compatible with the former SVHR model, this series ensures easier replacement.

Specifications

Carrying object	Wafers up to 300 mm			
	Arm	Rotation angle	Vertical stroke	
Operating range* (3rd joint center)	520 mm	330 degrees	20 mm	
Speed (Avg)*	300 mm/sec	120 degree/sec	20 mm/sec	
Speed (Max)*	550 mm/sec	170 degree/sec	30 mm/sec	
Resolution*	82 μm or less	0.009 degrees	1,25 μm	
Handling level*	98 mm (Flange mounting level to the end-effector level)			
Repeatability	Within +/- 0.1 mm			
Cleanliness	Magnetic fluid sealing and a filter			
Vacuum resistance	1.33 x 10 ⁻⁶ Pa			
Utility*	Power: 24 V DC +/-	- 10%, 8 A		

- * Representative specifications of SVCR3260-020-PM (stepping motor type)
- This series comes in two types of motors: stepping motors or AC servo motors.
- Robot's main body weight: Approximately 25 kg
- Dimensions of C4000 controller: 300 (W) x 110 (D) x 120 (H), Weight: Approximately 2 kg Note: A CE/KCs compliant controller has different dimensions and weight.

SVCR3000 series

♠ A wide range of variations to meet system layouts

SVCR

3 2 6 0
Arm length

0 2 0 Z-axis stroke



Z-axis s
6 0 0 4
9 0



 Check our website for our product drawings and videos.

https://www.jel-robot.com

jel

Search



Teaching box: JCT1

STVCR4160S-050-PM

4-Axis Cylindrical Coordinate Type Twin-Arm Clean Robot

Vacuum Clean Robot STVCR4000S Series

Suitable for various types of wafers up to 300 mm in a vacuum environment. Featuring an open-loop control system and stepping motors, this series ensures high safety and stability. This JEL's long-term standard robot allows users to customize easily.



Usage environment and specifications









Option







*CE or KCs marking is available upon request.

Transfer method





Controller: C4000

Control method: RS232C and parallel photo I/O



Teaching box: JC4B

Characteristics

- Suitable for vacuum environment
- Twin-arm reduces tact time to replace wafers.
- ◆ Magnetic fluid sealing is used in each arm joint.
- ◆ Vacuum sealing: Magnetic fluid sealing and a bellows are used.
- ◆ Cleanliness: A mesh filter is installed for the internal exhaust of each arm.
- ◆ Payload capacity: 2 kg or less (calculated on the arm 3rd joint)
- ◆ Compatible with the former STVHR model, this series ensures easier replacement,

Specifications

Carrying object	Wafers up to 300 mm			
	Arm	Rotation angle	Vertical stroke	
Operating range* (3rd joint center)	310 mm	330 degrees	50 mm	
Speed (Avg)*	300 mm/sec	110 degree/sec	30 mm/sec	
Speed (Max)*	550 mm/sec	150 degree/sec	50 mm/sec	
Resolution*	10.06 μm or less	0.00225 degrees	0.625 μm	
Handling level*	196 mm (Flange mounting level to the upper end-effector level)			
Repeatability	Within +/- 0.1 mm	Within +/- 0.1 mm		
Cleanliness	Magnetic fluid sealing and filters			
Vacuum resistance	1.33 x 10 ⁻⁶ Pa			
Utility*	Power: 24 V DC +/-	- 10%, 16 A		

- * Representative specifications of STVCR4160S-050-PM (stepping motor type)
- This series comes in two types of motors: stepping motors or AC servo motors with absolute encoders.
- Robot's main body weight: Approximately 80 kg
- Dimensions of C4000 controller: 300 (W) x 110 (D) x 120 (H), Weight: Approximately 2 kg Note: A CE/KCs compliant controller has different dimensions and weight.

STVCR4000 series

◆ A wide range of variations to meet system layouts

T V C R 4 1 6 0 Arm lengtl



 Check our website for our product drawings and videos.

https://www.jel-robot.com

jel



Please contact our sales representatives for details of this product.

GTVCR5330-060-AM

5-Axis Horizontal and Multi-Joint Type Single-Arm Twin End-Effector Clean Robot

Vacuum Clean Robot GTVCR5000 Series

Capable of transferring to parallel stages in vacuum chambers.

Featuring AC servo motors that are capable of high-speed handling, this series ensures high safety and stability. Suitable for various types of wafers or substrates as well as wafers up to 300 mm in a vacuum environment.



Characteristics

- ◆ Suitable for vacuum environment
- Capable of transferring to parallel stages in vacuum chambers.
- ◆ Magnetic fluid sealing is used in each arm joint.
- ◆ Vacuum sealing: Magnetic fluid sealing and a bellows are used.
- ◆ Cleanliness: A mesh filter is installed for the internal exhaust of each arm,
- ◆ Payload capacity: 4 kg or less (calculated on the arm 3rd joint)

Specifications

Carrying object	Wafers up to 300 mm			
	Arm	Rotation angle	Vertical stroke	
Operating range* (3rd joint center)	635 mm	360 degrees	60 mm	
Speed (Avg)*	640 mm/sec	160 degree/sec	60 mm/sec	
Speed (Max)*	950 mm/sec	200 degree/sec	85 mm/sec	
Resolution*	0.00081 degrees	0.00072 degrees	0.98 μm	
Handling level*	219 mm (Flange mounting level to the upper end-effector level)			
Repeatability	Within +/- 0.1 mm			
Cleanliness	Magnetic fluid sealing and a filter			
Vacuum resistance	1.33 x 10 ⁻⁶ Pa			
Utility*	Power: Single phase 200 to 230 V AC +10% to -15%, 2 kVA, 50/60 Hz			

- * Representative specifications of GTVCR5330-060-AM
- Robot's main body weight: Approximately 75 kg
- Dimensions of C5000S controller: 370 (W) x 330 (D) x 270 (H), Weight: Approximately 23 kg Note: A CE/KCs compliant controller has different dimensions and weight.

GTVCR5000 series

A wide range of variations to meet system layouts

GTCR5330 - 060 - AM
Arm length
280

 Check our website for our product drawings and videos.

https://www.jel-robot.com

jel

Search



Teaching box: JCT5B

SAL38C4HV

Aligner for Multiple Types of Wafers

A prealigner for aligning multiple types of wafers—regardless of wafer materials such as mirror surface, transparent or translucent wafer; warped wafer; or non-standard notch or orientation flat.

Just one aligner handles ever-difficult positioning of wafers with irregular warpage or different light transmittance. (*1)



Characteristics

- Available for silicon wafers with BG tape as well as silicon, transparent, or translucent wafers,
- ◆ Available for non-SEMI standard notch or flat.
- ◆ Z-axis capable of redo operations is optional.
- ◆ Full auto-adjustment software JEL ALIGN TOOL comes with the aligner.
- ◆ Motor drivers and a controller are built in the aligner.

Specifications

Carrying object	2 inch to 150 mm (SAL3264HV) 100 to 200 mm (SAL3484HV) 200 to 300 mm (SAL38C4HV)
Positioning time	Centering: 3 sec (*1)
Positioning accuracy	Centering: Within +/- 0.1 mm (*1) Orientation flat/notch locating: Within +/- 0.1 degrees (*1)
Sensor method	LED lighting with wafer edge detection using an image sensor unit
Wafer size switching	Switching by command control or by communication
Cleanliness	ISO Class 2 (when exhausted from the driving area)
Utility	Power: 24 V DC +/- 10%, 3 A; Vacuum: -53 kPa or more

- Aligner's main body weight: Approximately 10 kg
- (*1): The accuracies of wafer detection, positioning time or positioning may vary depending on the wafer.

 An operation test using the target sample wafers is performed before delivery.

SAL3000HV series

◆ A wide range of variations to meet your wafer size

SAL 3 8 C 4 H V Z *

Wafer size

2 6
4 8

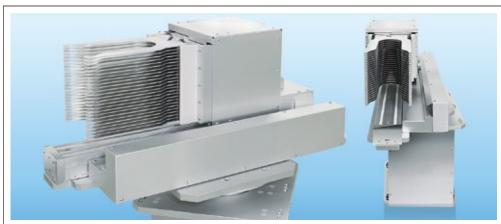
 Check our website for our product drawings and videos.

https://www.jel-robot.com

jel

Search

Please contact our sales representatives for details of this product.



KHR3480-290-AM Atmosphere

Linear arm type clean robot (for 25 wafers batch transfer, 300 mm wafers)

Capable of transferring 25 wafers at once.

The transfer time can be significantly reduced by batch transfer. Available for the layout with multiple cassettes by equipping a rotation axis.

Characteristics

- RS232C are standard for control.
- End-effector material: ceramic
- ◆ Wafer holding: end-effector with passive edge, edge alignment.
- ◆ AC servo motors with absolute encoders installed in all axes (Batteryless)

GCR4280-300-AM Atmosphere

4-Axis Horizontal and Multi-Joint Type Single-Arm Clean Robot

Clean Robot GCR4280-AM Series

Characteristics

- Arm length: 280 mm
- ◆ 3 FOUP access for 300 mm wafers without a track
- ◆ Vertical stroke: 300 mm. 420 mm
- Payload capacity: 4 kg or less (calculated on the arm 3rd joint)
- ◆ Base or flange mounting type is selectable according to system layouts.
- ◆ AC servo motors with absolute encoders are installed in all axes
- ◆ Wafer holding: end-effector with vacuum suction, passive edge, or edge grip



MCR3160C-300-AM Atmosphere

3-Axis Cylindrical Coordinate Type Single-Arm Clean Robot

Clean Robot MCR3000C Series

High-speed handling by AC servo motors for all axes. Suitable for high throughput.

Characteristics

- ◆ Arm length: 160 mm, 200 mm, 280 mm
- ♦ Vertical stroke: 300 mm, 400 mm, 420 mm, 500 mm
- ◆ Payload capacity: 4 kg or less (calculated on the arm 3rd joint)
- ◆ Base or flange mounting type is selectable according to system layouts.
- ◆ AC servo motors with absolute encoders are installed in all axes.
- ◆ Wafer holding: end-effector with vacuum suction, passive edge. edge grip, or Bernoulli type



MTCR4160-300-AM Atmosphere

4-Axis Cylindrical Coordinate Type Twin-Arm Clean Robot

Clean Robot MTCR4000 Series

High-speed handling by AC servo motors for all axes. Suitable for high throughput.

Characteristics

- ◆ Arm length: 160 mm, 200 mm, 280 mm
- ♦ Vertical stroke: 300 mm, 400 mm, 420 mm, 500 mm
- ◆ Payload capacity: 4 kg or less (calculated on the arm 3rd joint)
- ◆ Twin-arm reduces tact time to replace wafers.
- Base or flange mounting type is selectable according to system layouts.
- ◆ AC servo motors with absolute encoders are installed in all axes.
- ◆ Wafer holding: end-effector with vacuum suction, passive edge, edge grip, or Bernoulli type



SVCR3330-060-AM Vacuum

3-Axis Cylindrical Coordinate Type Single-Arm Clean Robot

Vacuum Clean Robot SVCR3000 Series

Designed for handing of heavy weight carrying objects such as susceptors or trays in vacuum chambers.

Characteristics

- Arm length: 330 mm
- ◆ Vertical stroke: 60 mm
- ◆ Payload capacity: 10 kg or less (calculated on the arm 3rd joint)
- ◆ Magnetic fluid sealing is used in each arm joint.
- Vacuum sealing: Magnetic fluid sealing and a bellows are used.
- ◆ Cleanliness: A mesh filter is installed for the internal exhaust of the arm ♠ AC servo motors with absolute encoders are installed in all axes
- ◆ Wafer holding: end-effector with passive edge



SWCR3160CS-300-PM Waterproof



3-Axis Cylindrical Coordinate Type Single-Arm Clean Robot

Waterproof Clean Robot SWCR3000 Series

Edge grip with the flip function for 300 mm wafers.

Designed for handling wafers in LSI production lines under acid conditions or alkaline mist (IP64).

Characteristics

- Arm length: 160 mm
- ◆ Vertical stroke: 200 mm, 300 mm
- Payload capacity: 3 kg or less (calculated on the arm 3rd joint)
- Corrosion resistance teflon coatings protect the arm.
- V-type seals are used for waterproofing of the arm joint.
- FKM seals are used for parts joint.
- A bellows is used for waterproofing of the z-axis.
- 2-phase stepping motors are installed in all axes.
- Wafer holding: end-effector with vacuum suction, passive edge, or edge grip



STWCR4160S-300-PM Waterproof



4-Axis Cylindrical Coordinate Type Twin-Arm Clean Robot

Waterproof Clean Robot STWCR4000 Series

Edge grip with the flip function for 300 mm wafers.

Designed for handling wafers in LSI production lines under acid conditions or alkaline mist (IP64).

Characteristics

- ◆ Vertical stroke: 200 mm, 300 mm
- Payload capacity: 3 kg or less (calculated on the arm 3rd joint)
- Corrosion resistance teflon coatings protect the arm.
- V-type seals are used for waterproofing of the arm joint.
- FKM seals are used for parts joint.
- A bellows is used for waterproofing of the z-axis.
- Twin-arm reduces tact time to replace wafers.
- 2-phase stepping motors are installed in all axes.
- ◆ Wafer holding: end-effector with vacuum suction, passive edge, or edge grip



SAL20C1 Atmosphere



Edge Grip Type Aligner for 300 mm Wafers

Edge grip type prealigner minimizes a wafer contact.

Characteristics

- ♦ High-speed and high-accuracy wafer centering and notch locating by the edge grip function.
- Designed to reduce contamination of friction surface.
- ◆ Suitable for 150 mm, 200 mm or other sizes of wafers
- Motor drivers and a controller are built in the aligner.



SVAL3001 Vacuum



Vacuum Aligner

Edge grip type prealigner for positioning silicon wafers or susceptors in a vacuum environment.

Characteristics

- ◆ Pavload capacity: 4 kg
- ◆ Stand-alone aligner using a vacuum resistance positioning sensor
- ◆ Vacuum sealing: Magnetic fluid sealing and a bellows are used.
- ◆ Rotation to any angle by index function which matches a layout of wafers in a tray



Transfer System Atmosphere

Tabletop Loader System / Sorter System / Automatic Wafer Transfer System for Wafer Container

A variety of systems from a tabletop to a large box shape to meet your needs

Tabletop Loader System



Automatic Wafer Transfer System for Wafer Container



Sorter System



End-Effector Lineup

Vacuum Suction Type End-Effector

I-shaped and Y-shaped vacuum suction type end-effectors

Used extensively for atmospheric robots, these vacuum suction type end-effectors hold the backside of a wafer by vacuum suction (negative pressure).

Conductive teflor coating on the surface of the end-effectors protect against damage from charging.

			Ĭ	Ĭ	Y	Y
Model	SC-IW-200	SC-IW-240	SC-YW-200	SC-YW-227	3D-02229	3D-01661
Carrying object	Mainly silicon wafers					
Size	3 inch, 100 to 200 mm	3 inch, 100 to 200 mm	100 to 200 mm	100 to 200 mm	150 to 300 mm	300 mm
Total length	200 mm	240 mm	200 mm	227 mm	242 mm	242 mm
Thickness	2 mm	2 mm	2 mm	2 mm	2 mm	3 mm
Material	High purity alumina ceramic sintered body					
Surface treatment	Conductive teflon coating					
Wafer holding	Vacuum suction					
Other end-effectors for various shapes and sizes of wafers or substrates are also available.						

Bernoulli Hand

A Bernoulli wand for 2 to 3 inch. 100 to 150 mm wafers

in semiconductor device production processes or in semiconductor wafer manufacturing factories, this wafer handling device is used to manually pick up/place thin wafers from/in wafer containers or cassettes.

Bernoulli Hand, a light and compact wand, holds thin wafers using the Bernoulli principle. Wafer breakage risk is minimized due to non-suction holding.

With the flexible front edge, Bernoulli Hand picks up/places wafers from/in wafer containers or wafer cassettes. Accessible to various special substrates as well as wafers.

Characteristics

- Wafers are lifted by the Cyclone effect.
- Wafer holding by a pad (Fluorine-contained rubber)
- An operator can adjust Bernoulli Hand in various angles with a flexible tube.

Note: Please contact our sales representatives for various shapes and sizes of other wafers or substrates.



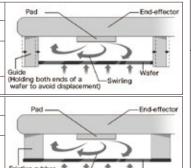
Bernoulli End-Effector

Contact type and non-contact type Bernoulli end-effectors

Low cost end-effectors for thin or warped wafers using the Bernoulli principle are suitable for any type of JEL atmospheric robots. Design solution and evaluation using sample wafers based on the customer's request about the wafer size, warpage or thickness.



Z	Material Aluminum		Pa
П- СС	Surface treatment	Black alumite	
Non-contact ty	Wafer holding method	By Bernoulli's principle using Cyclone pads and guides (PEEK) (Various materials are available for the contact area.)	Guide
tvpe	Utility 30 to 80 L/min (Varies depending on the wafer size and thickness.)		(Holding wafer t
	Material	Aluminum	
Cont	Surface treatment Black alumite		
Contact type	Wafer holding method	By Bernoulli's principle using Cyclone pads and friction rubber (H-NBR) (Various materials are available for the contact area.)	Friction
	Utility	30 to 80 L/min (Varies depending on the wafer size and thickness.)	1110001



Edge Grip End-Effector

An end-effector for handling the back side treated wafers, which contacts the edges only.

Centering of a wafer during operation is suitable for transferring to the drop-in type stage. An air cylinder moves a guide of the edge grip end-effector back and forth to hold a wafer.



Passive Edge Holding Type End-Effector

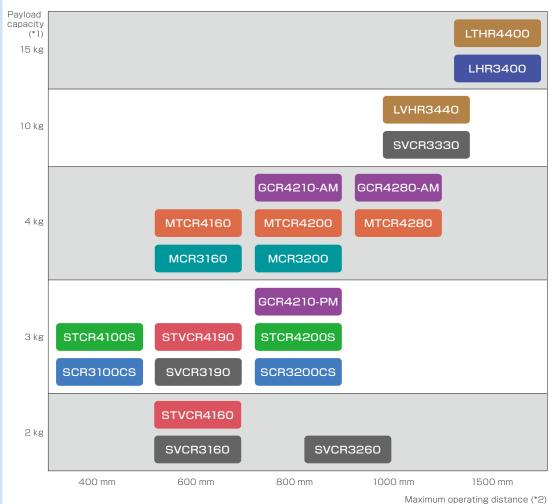
Suitable for handling warped wafers or thin wafers that cannot be held properly with a standard vacuum suction type end-effector.

An end-effector for handling wafers, which contacts the back side as well as the edges. A tapered guide is used to hold a wafer by the weight of a wafer (passive grip).



How to Select JEL Robots

Payload Capacity and Maximum Operating Range



(*1) Payload capacity values are the values calculated on the arm 3rd joint, and not the weight of carrying objects. (*2) Maximum operating distance values are reference values including the end-effector and wrist-block.

Note: Many products other than those listed are available. For more details, visit our website: www.jel-robot.com

Product Series

	Single arm	Twin arm	Main use and transfer method
	SCR3000CS	STCR4000S	For semiconductors (Cylindrical)
	SCR3000CSN	STCR4000SN	For semiconductors (Cylindrical)
Atmospheric robot	MCR3000	MTCR4000	For semiconductors (Cylindrical)
Ισυστ	GCR4000	GTCR5000	For semiconductors (Horizontal and multi-joint)
	LHR3000	LTHR4000	For FPD glass substrates (Cylindrical)
Vacuum robot	SVCR3000	STVCR4000	For semiconductors (Cylindrical)
Waterproof robot	SWCR3000CS	STWCR4000S	For semiconductors (Cylindrical)

Transfer Method

Cylindrical coordinate type robot	Suitable for arc layout
Horizontal and multi-joint type robot	Suitable for parallel layout

Robot Training

JEL provides our customers with robot trainings for safe and effective operations.

[Training place]

- JEL Head office
- JEL Tokyo branch
- Overseas service base



Domestic service base

■ JEL CORPORATION

Head Office



2-8-20, Kusado-cho, Fukuyama-city, Hiroshima, 720-0831 JAPAN

TEL: +81-84-932-6500 E-mail: info@jel-robot.co.jp



Location map

Tokyo Branch



Kanda Bundo Building 2F. 4-18. Kandasakuma-cho, Chiyoda-ku, Tokyo, 101-0025 JAPAN

TEL: +81-3-5825-9071 E-mail: tokyjim@jel-robot.co.jp



Company profile

Name : JEL Corporation Capital : 74,570,000 (JPY)

• Founded : 1993 President: Nobuo Sakiva

Type of business: Manufacture and sales of electronic equipment

Major products

Main banks

: Wafer transfer robots and wafer handling systems for semiconductor equipment FPD glass substrate transfer robots and FPD glass handling systems

: The Bank of MUFG Bank, Ltd.

■ Contact our sales representative for product request or questions.



JEL CORPORATION https://www.jel-robot.com





ISO 1400 Head office

X ■ **4** You can also check

for products information

ducts videos are provided

The specifications are as at March 2025. Please note that the specifications on this leaflet may be modified without notice.

Actual products color might differ from the colors in this leaflet.
No part of this leaflet may be reproduced or transmitted in any form without permission.

Domestic production base

Saba Factory

■ JFL CORPORATION

245-1 Saba-cho, Fukuvama-city. Hiroshima, 720-0835 Japan TEL: +81-84-952-5590

Location map

JEL Kochi



Techno Park 4. Tosavamada-cho. Kami-city, Kochi, 782-0010 JAPAN

TEL: +81-887-53-1181 E-mail: kochi@jel-robot.co.jp



Overseas sales base

IFI CORPORATION

JEL (Shanghai) Robotics Co., Ltd.



625 6F, CHAMTIME Tower C, No.3, Lane 2889 Jinke Road, Pudong New District, Shanghai P.R., China

TEL: +86-21-2050-1625(Landline) +86-13021105268(Mobile) E-mail: shanghai@jel-robot.com

Korea Branch



F20Ho, 4F 401,402Ho, 526, Maesonggosaek-ro, Gwonseon-gu, Suwon-si, Gyeonggi-do 16634, Korea

TEL: Korea) +82-10-3481-6360 Japan) +81-80-6340-9905 (080-6340-9905) E-mail: ikl@iel-robot.co.ip

JEL (Changzhou) Robotics Technology Co., Ltd.



Building 5, Changzhou Oriental Automotive Electronics Industrial Park, No. 1668, Dongguan Road, Lucheng Street, Wujin District, Changzhou City, Jiangsu Province 213025, China

TEL: +86-13021105268(Mobile)

Sintaike Semiconductor

Equipment (Shanghai) Co., Ltd. http://www.sintaike.com

Building 6, Nanfang Urban Park, Lane 1165, Jindu Road, Minhang District, Shanghai 201108, China. TFI: +86-021-6088-8500

F-mail: info@sintaike.com

SINTAIKO

Overseas Agents & Service Bases

Korea



JELK CO., LTD. https://www.jelk.co.kr

75. Seokmun-ail, Seonggeo-eup. Seobuk-gu, Cheonan-si, Chungnam-do 31053, Korea

TEL: +82-41-583-6360 FAX: +82-41-583-6469 E-mail: master@jelk.co.kr



Challentech International Corporation

https://www.challentech.com.tw No.21. Taihe Rd., Zhubei Citv.

Shangha

Hsinchu County 30267, Taiwan (R.O.C.) TEL: +886-3-5536525 FAX: +886-3-5531908 E-mail: I obo@challentech.com.tw

BDA, Beijing 101111, China TEL: +86-10-5382-2087, +86-133-2115-2839

Beijing REJE

E-mail: xiaoshou06@reje.com.cn

https://www.reje.com.cn

Automation Co., Ltd.

Building 3, No.10, Kechuang 10th Street,

Overseas Agents



Inatech & CORP Inc.

http://www.inatechncorp.com #C-812, 168, Gasan digital 1-ro, Geumcheon-gu, Seoul 08507, Korea TEL: +82-2-2026-0660 FAX: +82-2-2026-0661 E-mail: jel-robot@inacorp.co.kr



Shanghai

Hine Automation, LLC

https://hineautomation.com 12495 34th St. North. Suite B St. Petersburg, FL 33716, U.S.A. TEL: +1-813-749-7519

AES motomation Inc.

http://www.motomation.com 4041 Clipper Court Fremont. CA 94538, U.S.A. TEL: +1-510-490-9400 E-mail: info@motomation.com

Shanghai REJE

Shanghai 201106, China

TEL: +86-178-1202-2295

Robotics Co., Ltd.

https://www.reje.com.cn

motomation

Room 306-11, Building T4, Libao Plaza,

U.S.A (CA

36 Shenbin Road, Minhang District,



JEL Automation Co., Ltd. https://www.jel-automation.com

1F., No. 29, Jiazheng 9th St., Zhubei City, Hsinchu County 302053. TEL: +886-3-6583741 E-mail: alex.chen@iel-automation.com



AES motomation GmbH

http://www.motomation.com Duesselstrasse 8a D-41564 Kaarst.

TEL: +49-0-2131-7768-10 E-mail: info@motomation.com

DISTRIBUTOR

202503A0